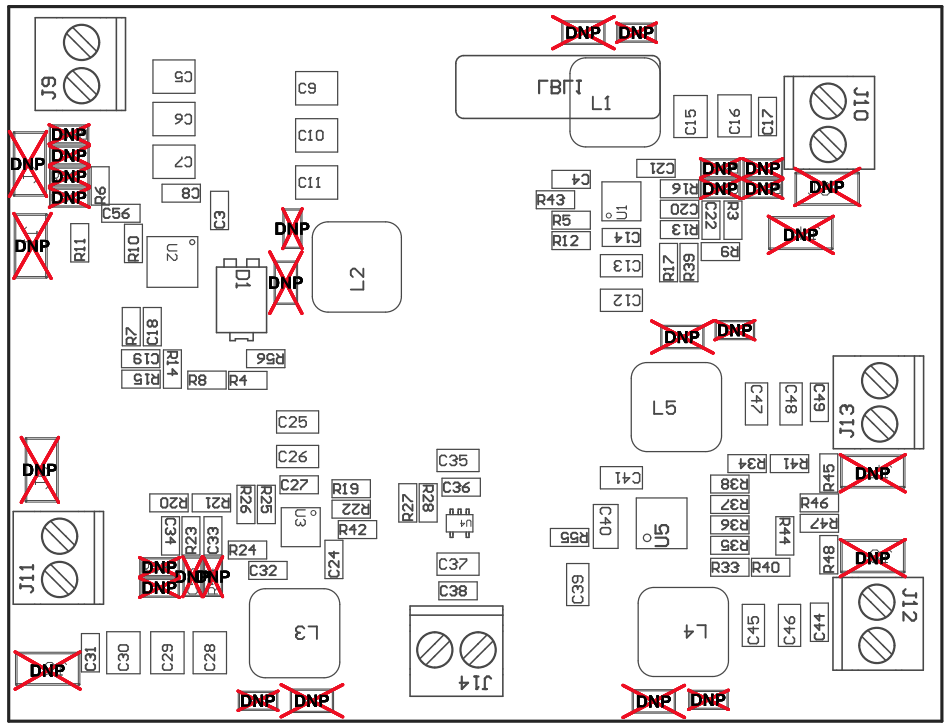
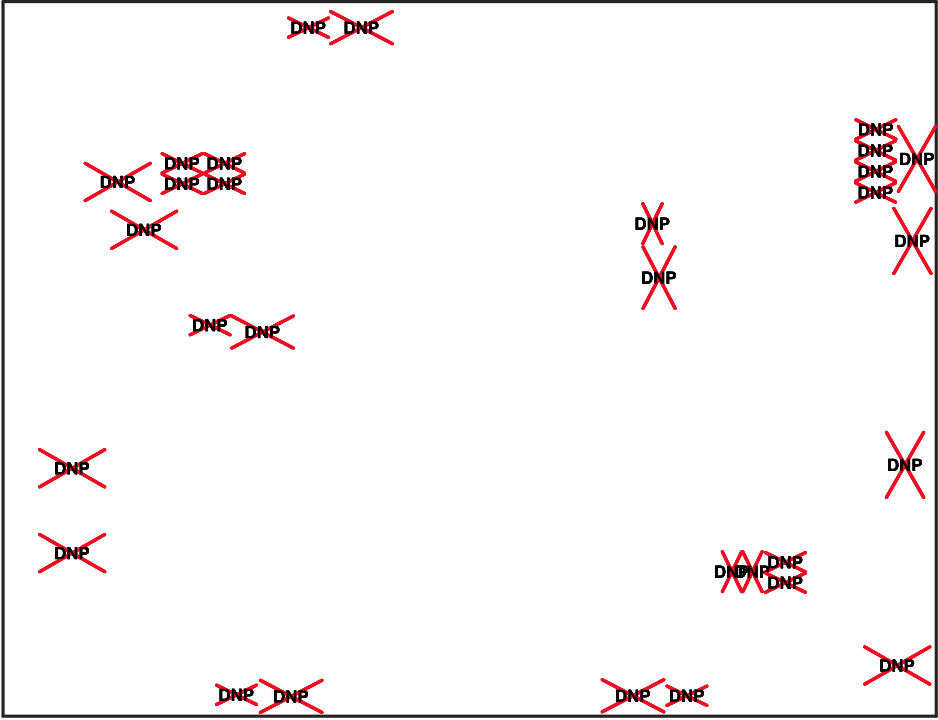


- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4442	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = M5 Assembly Top	TID #: TIDA-00804		
PLOT NAME = Top Assembly Drawing	GENERATED : 3/8/2016	2:42:46 PM	TEXAS INSTRUMENTS



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